

P2002,0637

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

: Werner Plass et al.

Confirmation No. 9553

Applic, No.

10/631,384

Filed

: July 31, 2003

Title

Surface Emitting Semiconductor Laser Chip and Method for

Producing the Chip

Examiner

Ahmed N. Sefer

Group Art Unit

2826

Docket No.

P2002,0637

Customer No.

24131

DECLARATION UNDER 37 C.F.R. § 1.131

The undersigned, Werner Plass, Christian Jung, Tony Albracht, Udo Streller, inventors of this invention, hereby declare that:

The invention of the above-identified application was conceived and "reduced to practice" at least as early as February 12, 2002.

The undersigned, Werner Plass, Christian Jung, Tony Albrecht, Udo Streller, developed Surface Emitting Semiconductor Laser Chip and Method for Producing the Chip according to the Invention and wrote the Invention Disclosure (Erfindungsmeldung).

Enclosed, as corroborating evidence, is the Invention Disclosure, which is a preprinted form signed by the undersigned. The Invention Disclosure was executed by the undersigned on November 2, 2001 (see signatures on the bottoms of page 4). The invention Disclosure was given to Mr. Luft, who is the inventors' superior, on November 7, 2001. On the right side in the upper half of the first page there is a box that indicates when the invention Disclosure was received by the inventors' superior. This box is labeled "Eingang am." (Received on) and the date "7.11.2001" is handwritten in this box. As is customary in Europe, the order of the handwritten date is day/month/year.

In the lower half of the first page of the Invention Disclosure Mr. Luft signed and dated the first page of the Invention Disclosure in order to confirm the receipt of the Invention Disclosure on November 7, 2001.

The Invention Disclosure was shortly thereafter further submitted to the corporate patent department of Slamens Aktiengesellschaft and it was received, as best understood, on November 14, 2001 (see the lower right corner of page 1).

The undersigned hereby declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Werner Plass 08 11.204	Christian Jung,	<u>\</u>
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Tony Albrecht OS. M. 200 4	Udo Streller	AVAIL
Date	Date	BEST



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Werner Plass	Christian Jung, 09.11.2004
Date	Date
Tony Albrecht	Udo Streller
Date	Date



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: Ahmed N. Sefer

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Werner Plass	Christian Jung,
Date	Date
Tony Albrecht	Udo Streller
Date	09.11.2004 Date

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